

Surface Mount P-Channel Enhancement Mode MOSFET

 **Lead(Pb)-Free**

Features:

- * Super high dense
- * Cell design for low RDS(ON)
- * $R_{DS(ON)} < 130\text{m}\Omega @ V_{GS} = -4.5\text{V}$
- * $R_{DS(ON)} < 180\text{m}\Omega @ V_{GS} = -2.5\text{V}$
- * Simple Drive Requirement
- * Lower On-resistance
- * Fast Switching

Description:

The WTK9431 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

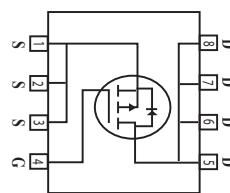
The SOP-8 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

Maximum Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Specified)

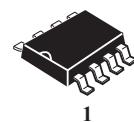
Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current ⁽³⁾ $(T_A = 25^\circ\text{C})$ $(T_A = 70^\circ\text{C})$	I_D	-3.5 -2.8	A
Pulsed Drain Current ^(1,2)	I_{DM}	-18	A
Power Dissipation	P_D	2.5	W
Maximax Junction-to-Ambient	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$
Operating Junction Temperature Range	T_J	+150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

Device Marking

WTK9431=9431SC



DRAIN CURRENT
-3.5 AMPERES
DRAIN SOURCE VOLTAGE
-20 VOLTAGE



SOP-8

Electrical Characteristics ($T_A=25^\circ\text{C}$ Unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Static					
Drain-Source Breakdown Voltage $V_{GS}=0\text{V}, I_D=-250 \mu\text{A}$	$V_{(\text{BR})\text{DSS}}$	-20	-	-	V
Gate-Source Threshold Voltage $V_{DS}=V_{GS}, I_D=-250 \mu\text{A}$	$V_{GS} (\text{th})$	-0.4	-	-1.0	V
Gate-Source Leakage Current $V_{DS}=0\text{V}, V_{GS}=\pm 8\text{V}$	I_{GSS}	-	-	± 100	nA
Zero Gate Voltage Drain Current $V_{DS}=-16\text{V}, V_{GS}=0\text{V}$ $V_{DS}=-12\text{V}, V_{GS}=0\text{V}$	I_{DSS}	-	-	-1 -25	μA
Drain-Source On-Resistance ⁽²⁾ $V_{GS}=-10\text{V}, I_D=-5.3\text{A}$ $V_{GS}=-4.5\text{V}, I_D=-4.2\text{A}$	$R_{DS(\text{on})}$	-	-	130 180	$\text{m}\Omega$
Forward Transconductance ⁽²⁾ $V_{DS}=-5\text{V}, I_D=-3.5\text{A}$	g_{fs}	-	6.5	-	S

Dynamic

Input Capacitance $V_{DS}=-10\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	C_{iss}	-	405	-	pF
Output Capacitance $V_{DS}=-10\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	C_{oss}	-	170	-	
Reverse Transfer Capacitance $V_{DS}=-10\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	C_{rss}	-	45	-	

Switching

Turn-On Delay Time ⁽²⁾ $V_{DD}=-5\text{V}, I_D=-1\text{A}, V_{GS}=-4.5\text{V}, R_G=6\Omega$	$t_{d(\text{on})}$	-	6.5	-	nS
Rise Time $V_{DD}=-5\text{V}, I_D=-1\text{A}, V_{GS}=-4.5\text{V}, R_G=6\Omega$	t_r	-	20	-	nS
Turn-Off Time $V_{DD}=-5\text{V}, I_D=-1\text{A}, V_{GS}=-4.5\text{V}, R_G=6\Omega$	$t_{d(\text{off})}$	-	31	-	nS
Fall Time $V_{DD}=-5\text{V}, I_D=-1\text{A}, V_{GS}=-4.5\text{V}, R_G=6\Omega$	t_f	-	21	-	nS
Total Gate Charge ⁽²⁾ $V_{DS}=-5\text{V}, I_D=-5.3\text{A}, V_{GS}=-4.5\text{V}$	Q_g	-	6	8.5	nc
Gate-Source Charge $V_{DS}=-5\text{V}, I_D=-5.3\text{A}, V_{GS}=-4.5\text{V}$	Q_{gs}	-	0.8	-	nc
Gate-Drain Charge $V_{DS}=-5\text{V}, I_D=-5.3\text{A}, V_{GS}=-4.5\text{V}$	Q_{gd}	-	1.3	-	nc
Drain-Source Diode Forward Voltage ⁽²⁾ $V_{GS}=0\text{V}, I_S=-2.1\text{A}$	V_{SD}	-	-	-1.2	V
Continuous Source Current (Body Diode) $V_D=V_G=0\text{V}, V_S=-1.2\text{V}$	I_S	-	-	-2.1	A

Notes: 1. Pulse width limited by Max. junction temperature.

2. Pulse width 300μs, duty cycle ≤ 2%.

3. Surface mounted on 1 in² copper pad of FR4 board; 125°C/W when mounted on Min. copper pad.

Characteristics Curve

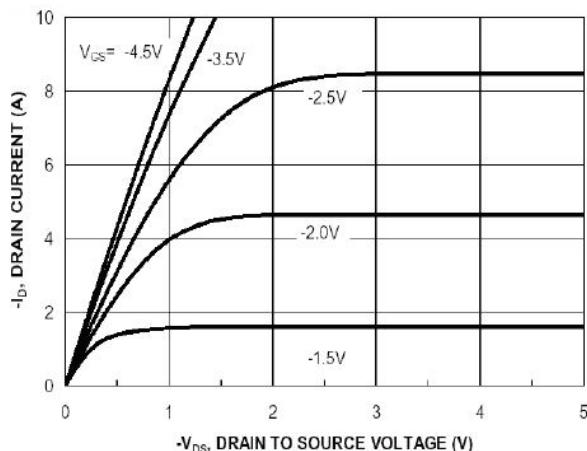


Fig 1. Typical Output Characteristics

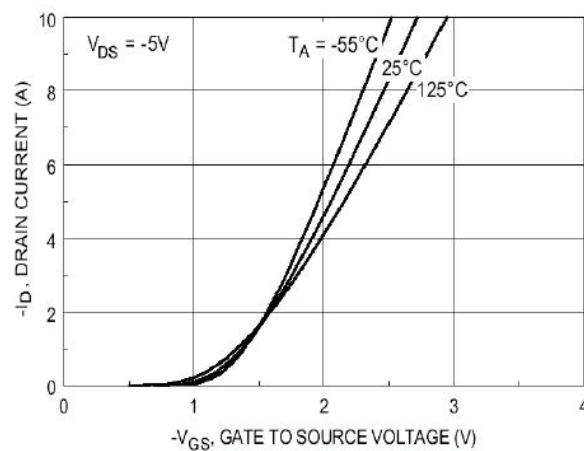


Fig 2. Transfer Characteristics

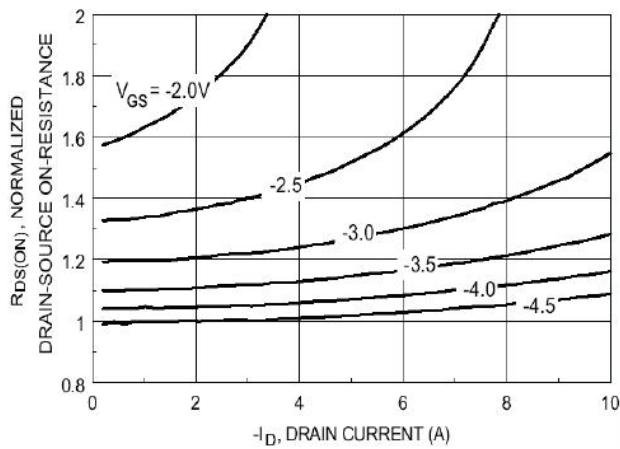


Fig 3. On-Resistance v.s. Drain Current and Gate Voltage

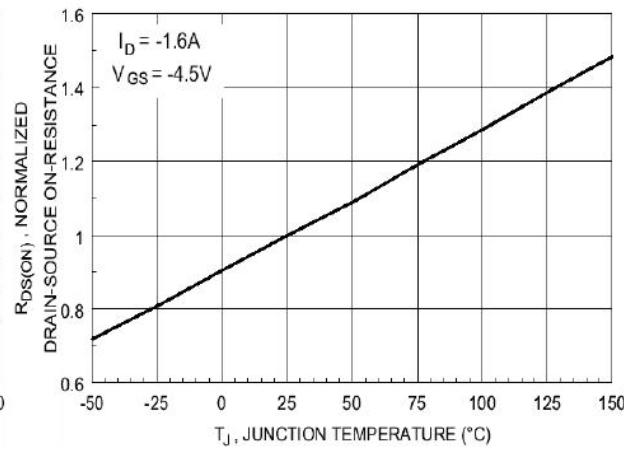


Fig 4. On-Resistance v.s. Junction Temperature

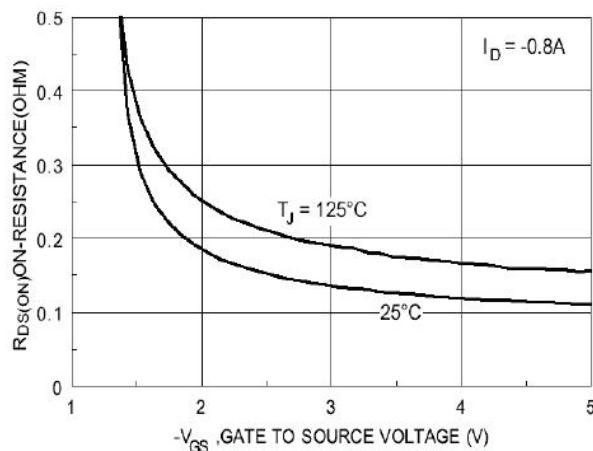


Fig 5. On-Resistance v.s. Gate-Source Voltage

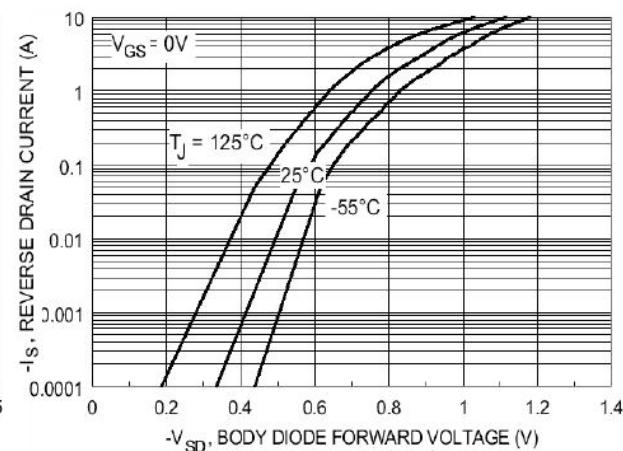
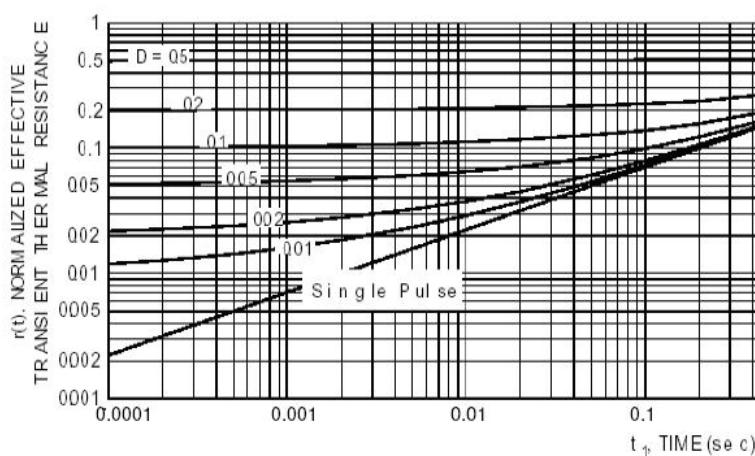
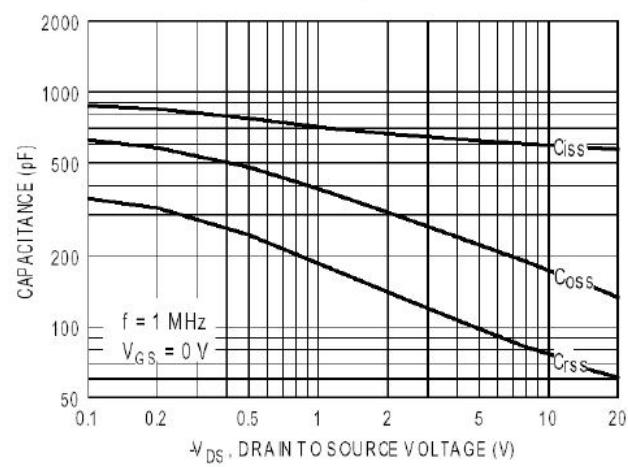
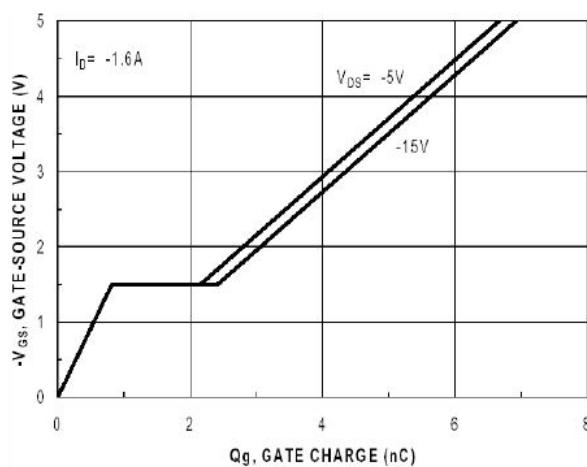
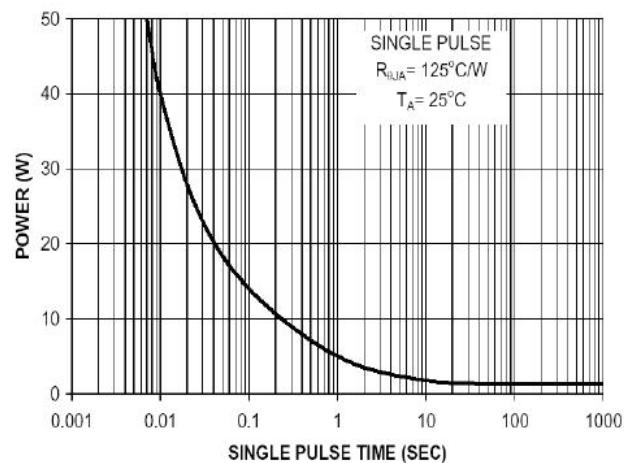
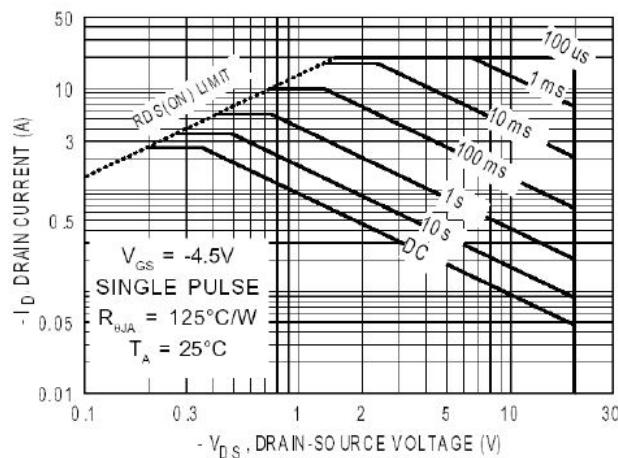
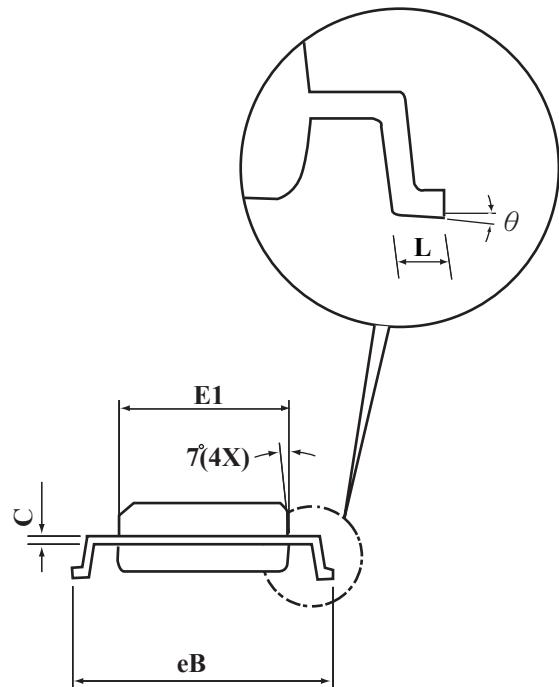
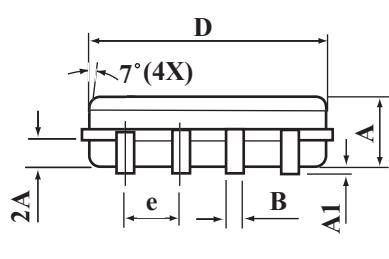
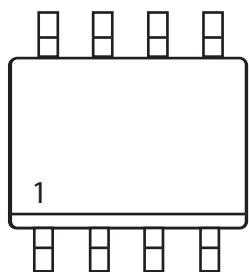


Fig 6. Body Diode Characteristics



SOP-8 Package Outline Dimensions

Unit:mm



SYMBOLS	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.20
B	0.35	0.45
C	0.18	0.23
D	4.69	4.98
E1	3.56	4.06
Be	5.70	6.30
e	1.27 BSC	
L	0.60	0.80
θ	0°	8°